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### Understanding [Embedded - FPGAs \(Field Programmable Gate Array\)](#)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

### Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

#### Details

|                                |   |
|--------------------------------|---|
| Product Status                 | Obsolete  |
| Number of LABs/CLBs            | 1024  |
| Number of Logic Elements/Cells | 2432  |
| Total RAM Bits                 | 32768   |
| Number of I/O                  | 193   |
| Number of Gates                | 28000   |
| Voltage - Supply               | 3V ~ 3.6V   |
| Mounting Type                  | Surface Mount   |
| Operating Temperature          | 0°C ~ 85°C (TJ)   |
| Package / Case                 | 240-BFQFP Exposed Pad   |
| Supplier Device Package        | 240-PQFP (32x32)  |
| Purchase URL                   | <a href="https://www.e-xfl.com/product-detail/xilinx/xc4028xl-2hq240c">https://www.e-xfl.com/product-detail/xilinx/xc4028xl-2hq240c</a> |

### ***Input Thresholds***

The input thresholds of 5V devices can be globally configured for either TTL (1.2 V threshold) or CMOS (2.5 V threshold), just like XC2000 and XC3000 inputs. The two global adjustments of input threshold and output level are independent of each other. The XC4000XL family has an input threshold of 1.6V, compatible with both 3.3V CMOS and TTL levels.

### ***Global Signal Access to Logic***

There is additional access from global clocks to the F and G function generator inputs.

### ***Configuration Pin Pull-Up Resistors***

During configuration, these pins have weak pull-up resistors. For the most popular configuration mode, Slave Serial, the mode pins can thus be left unconnected. The three mode inputs can be individually configured with or without weak pull-up or pull-down resistors. A pull-down resistor value of 4.7 k $\Omega$  is recommended.

The three mode inputs can be individually configured with or without weak pull-up or pull-down resistors after configuration.

The PROGRAM input pin has a permanent weak pull-up.

### ***Soft Start-up***

Like the XC3000A, XC4000 Series devices have "Soft Start-up." When the configuration process is finished and the device starts up, the first activation of the outputs is automatically slew-rate limited. This feature avoids potential ground bounce when all outputs are turned on simultaneously. Immediately after start-up, the slew rate of the individual outputs is, as in the XC4000 family, determined by the individual configuration option.

### ***XC4000 and XC4000A Compatibility***

Existing XC4000 bitstreams can be used to configure an XC4000E device. XC4000A bitstreams must be recompiled for use with the XC4000E due to improved routing resources, although the devices are pin-for-pin compatible.

## **Additional Improvements in XC4000X Only**

### ***Increased Routing***

New interconnect in the XC4000X includes twenty-two additional vertical lines in each column of CLBs and twelve new horizontal lines in each row of CLBs. The twelve "Quad Lines" in each CLB row and column include optional repowering buffers for maximum speed. Additional high-performance routing near the IOBs enhances pin flexibility.

### ***Faster Input and Output***

A fast, dedicated early clock sourced by global clock buffers is available for the IOBs. To ensure synchronization with the regular global clocks, a Fast Capture latch driven by the early clock is available. The input data can be initially loaded into the Fast Capture latch with the early clock, then transferred to the input flip-flop or latch with the low-skew global clock. A programmable delay on the input can be used to avoid hold-time requirements. See "IOB Input Signals" on page 20 for more information.

### ***Latch Capability in CLBs***

Storage elements in the XC4000X CLB can be configured as either flip-flops or latches. This capability makes the FPGA highly synthesis-compatible.

### ***IOB Output MUX From Output Clock***

A multiplexer in the IOB allows the output clock to select either the output data or the IOB clock enable as the output to the pad. Thus, two different data signals can share a single output pad, effectively doubling the number of device outputs without requiring a larger, more expensive package. This multiplexer can also be configured as an AND-gate to implement a very fast pin-to-pin path. See "IOB Output Signals" on page 23 for more information.

### ***Additional Address Bits***

Larger devices require more bits of configuration data. A daisy chain of several large XC4000X devices may require a PROM that cannot be addressed by the eighteen address bits supported in the XC4000E. The XC4000X Series therefore extends the addressing in Master Parallel configuration mode to 22 bits.

## Detailed Functional Description

XC4000 Series devices achieve high speed through advanced semiconductor technology and improved architecture. The XC4000E and XC4000X support system clock rates of up to 80 MHz and internal performance in excess of 150 MHz. Compared to older Xilinx FPGA families, XC4000 Series devices are more powerful. They offer on-chip edge-triggered and dual-port RAM, clock enables on I/O flip-flops, and wide-input decoders. They are more versatile in many applications, especially those involving RAM. Design cycles are faster due to a combination of increased routing resources and more sophisticated software.

### Basic Building Blocks

Xilinx user-programmable gate arrays include two major configurable elements: configurable logic blocks (CLBs) and input/output blocks (IOBs).

- CLBs provide the functional elements for constructing the user's logic.
- IOBs provide the interface between the package pins and internal signal lines.

Three other types of circuits are also available:

- 3-State buffers (TBUFs) driving horizontal longlines are associated with each CLB.
- Wide edge decoders are available around the periphery of each device.
- An on-chip oscillator is provided.

Programmable interconnect resources provide routing paths to connect the inputs and outputs of these configurable elements to the appropriate networks.

The functionality of each circuit block is customized during configuration by programming internal static memory cells. The values stored in these memory cells determine the logic functions and interconnections implemented in the FPGA. Each of these available circuits is described in this section.

### Configurable Logic Blocks (CLBs)

Configurable Logic Blocks implement most of the logic in an FPGA. The principal CLB elements are shown in **Figure 1**. Two 4-input function generators (F and G) offer unrestricted versatility. Most combinatorial logic functions need four or fewer inputs. However, a third function generator (H) is provided. The H function generator has three inputs. Either zero, one, or two of these inputs can be the outputs of F and G; the other input(s) are from outside the CLB. The CLB can, therefore, implement certain functions of up to nine variables, like parity check or expandable-identity comparison of two sets of four inputs.

Each CLB contains two storage elements that can be used to store the function generator outputs. However, the storage elements and function generators can also be used independently. These storage elements can be configured as flip-flops in both XC4000E and XC4000X devices; in the XC4000X they can optionally be configured as latches. DIN can be used as a direct input to either of the two storage elements. H1 can drive the other through the H function generator. Function generator outputs can also drive two outputs independent of the storage element outputs. This versatility increases logic capacity and simplifies routing.

Thirteen CLB inputs and four CLB outputs provide access to the function generators and storage elements. These inputs and outputs connect to the programmable interconnect resources outside the block.

### Function Generators

Four independent inputs are provided to each of two function generators (F1 - F4 and G1 - G4). These function generators, with outputs labeled F' and G', are each capable of implementing any arbitrarily defined Boolean function of four inputs. The function generators are implemented as memory look-up tables. The propagation delay is therefore independent of the function implemented.

A third function generator, labeled H', can implement any Boolean function of its three inputs. Two of these inputs can optionally be the F' and G' functional generator outputs. Alternatively, one or both of these inputs can come from outside the CLB (H2, H0). The third input must come from outside the block (H1).

Signals from the function generators can exit the CLB on two outputs. F' or H' can be connected to the X output. G' or H' can be connected to the Y output.

A CLB can be used to implement any of the following functions:

- any function of up to four variables, plus any second function of up to four unrelated variables, plus any third function of up to three unrelated variables<sup>1</sup>
- any single function of five variables
- any function of four variables together with some functions of six variables
- some functions of up to nine variables.

Implementing wide functions in a single block reduces both the number of blocks required and the delay in the signal path, achieving both increased capacity and speed.

The versatility of the CLB function generators significantly improves system speed. In addition, the design-software tools can deal with each function generator independently. This flexibility improves cell usage.

1. When three separate functions are generated, one of the function outputs must be captured in a flip-flop internal to the CLB. Only two unregistered function generator outputs are available from the CLB.



**Figure 1: Simplified Block Diagram of XC4000 Series CLB (RAM and Carry Logic functions not shown)**

### Flip-Flops

The CLB can pass the combinational output(s) to the interconnect network, but can also store the combinational results or other incoming data in one or two flip-flops, and connect their outputs to the interconnect network as well.

The two edge-triggered D-type flip-flops have common clock (K) and clock enable (EC) inputs. Either or both clock inputs can also be permanently enabled. Storage element functionality is described in [Table 2](#).

### Latches (XC4000X only)

The CLB storage elements can also be configured as latches. The two latches have common clock (K) and clock enable (EC) inputs. Storage element functionality is described in [Table 2](#).

### Clock Input

Each flip-flop can be triggered on either the rising or falling clock edge. The clock pin is shared by both storage elements. However, the clock is individually invertible for each storage element. Any inverter placed on the clock input is automatically absorbed into the CLB.

### Clock Enable

The clock enable signal (EC) is active High. The EC pin is shared by both storage elements. If left unconnected for either, the clock enable for that storage element defaults to the active state. EC is not invertible within the CLB.

**Table 2: CLB Storage Element Functionality (active rising edge is shown)**

| Mode            | K | EC | SR | D | Q  |
|-----------------|---|----|----|---|----|
| Power-Up or GSR | X | X  | X  | X | SR |
| Flip-Flop       | X | X  | 1  | X | SR |
|                 |   | 1* | 0* | D | D  |
| Latch           | 0 | X  | 0* | X | Q  |
|                 | 1 | 1* | 0* | X | Q  |
| Both            | 0 | 1* | 0* | D | D  |
|                 | X | 0  | 0* | X | Q  |

Legend:

X

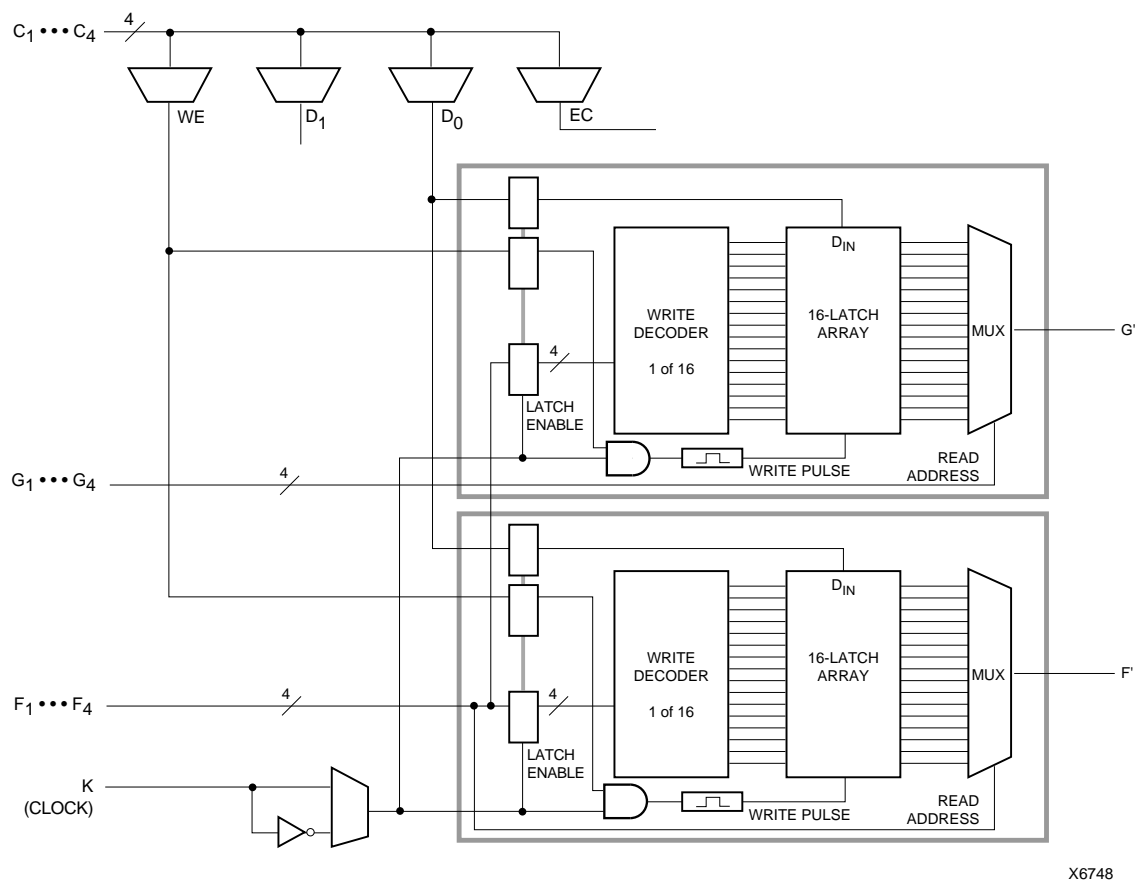
Rising edge

SR

Set or Reset value. Reset is default.

0\* Input is Low or unconnected (default value)

1\* Input is High or unconnected (default value)



X6748

Figure 7: 16x1 Edge-Triggered Dual-Port RAM

Figure 8 shows the write timing for level-sensitive, single-port RAM.

The relationships between CLB pins and RAM inputs and outputs for single-port level-sensitive mode are shown in Table 7.

Figure 9 and Figure 10 show block diagrams of a CLB configured as 16x2 and 32x1 level-sensitive, single-port RAM.

Initializing RAM at Configuration

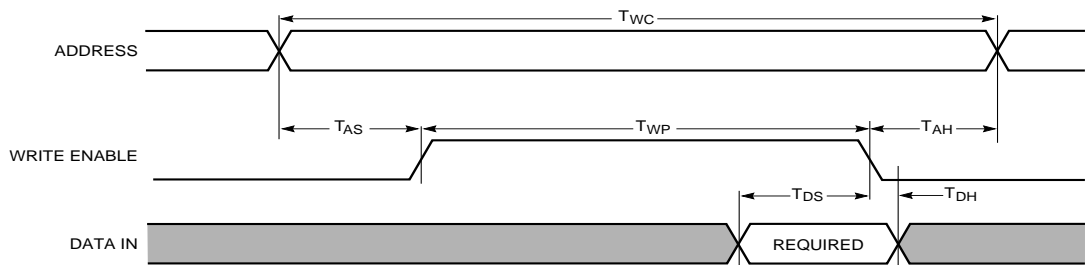
Both RAM and ROM implementations of the XC4000 Series devices are initialized during configuration. The initial contents are defined via an INIT attribute or property

attached to the RAM or ROM symbol, as described in the schematic library guide. If not defined, all RAM contents are initialized to all zeros, by default.

RAM initialization occurs only during configuration. The RAM content is not affected by Global Set/Reset.

Table 7: Single-Port Level-Sensitive RAM Signals

| RAM Signal | CLB Pin        | Function     |
|------------|----------------|--------------|
| D          | D0 or D1       | Data In      |
| A[3:0]     | F1-F4 or G1-G4 | Address      |
| WE         | WE             | Write Enable |
| O          | F' or G'       | Data Out     |



X6462

Figure 8: Level-Sensitive RAM Write Timing

### Fast Carry Logic

Each CLB F and G function generator contains dedicated arithmetic logic for the fast generation of carry and borrow signals. This extra output is passed on to the function generator in the adjacent CLB. The carry chain is independent of normal routing resources.

Dedicated fast carry logic greatly increases the efficiency and performance of adders, subtractors, accumulators, comparators and counters. It also opens the door to many new applications involving arithmetic operation, where the previous generations of FPGAs were not fast enough or too inefficient. High-speed address offset calculations in micro-processor or graphics systems, and high-speed addition in digital signal processing are two typical applications.

The two 4-input function generators can be configured as a 2-bit adder with built-in hidden carry that can be expanded to any length. This dedicated carry circuitry is so fast and efficient that conventional speed-up methods like carry generate/propagate are meaningless even at the 16-bit level, and of marginal benefit at the 32-bit level.

This fast carry logic is one of the more significant features of the XC4000 Series, speeding up arithmetic and counting into the 70 MHz range.

The carry chain in XC4000E devices can run either up or down. At the top and bottom of the columns where there are no CLBs above or below, the carry is propagated to the right. (See Figure 11.) In order to improve speed in the high-capacity XC4000X devices, which can potentially have very long carry chains, the carry chain travels upward only, as shown in Figure 12. Additionally, standard interconnect can be used to route a carry signal in the downward direction.

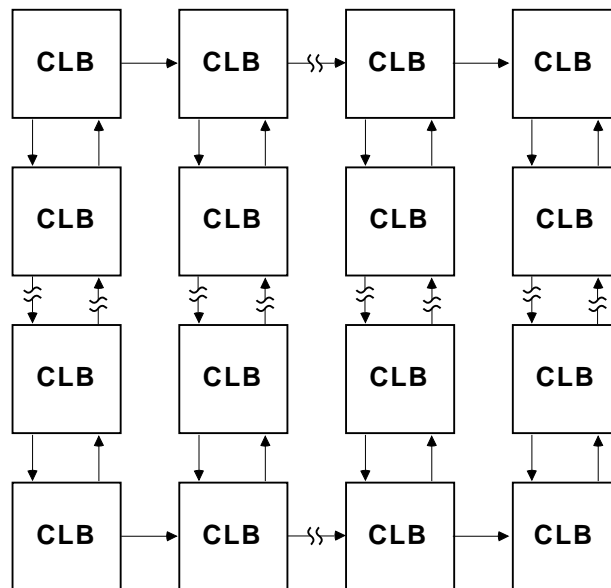
Figure 13 on page 19 shows an XC4000E CLB with dedicated fast carry logic. The carry logic in the XC4000X is similar, except that COUT exits at the top only, and the signal CINDOWN does not exist. As shown in Figure 13, the carry logic shares operand and control inputs with the function generators. The carry outputs connect to the function generators, where they are combined with the operands to form the sums.

Figure 14 on page 20 shows the details of the carry logic for the XC4000E. This diagram shows the contents of the box labeled "CARRY LOGIC" in Figure 13. The XC4000X carry logic is very similar, but a multiplexer on the pass-through carry chain has been eliminated to reduce delay. Additionally, in the XC4000X the multiplexer on the G4 path has a memory-programmable 0 input, which permits G4 to directly connect to COUT. G4 thus becomes an additional high-speed initialization path for carry-in.

The dedicated carry logic is discussed in detail in Xilinx document XAPP 013: "Using the Dedicated Carry Logic in

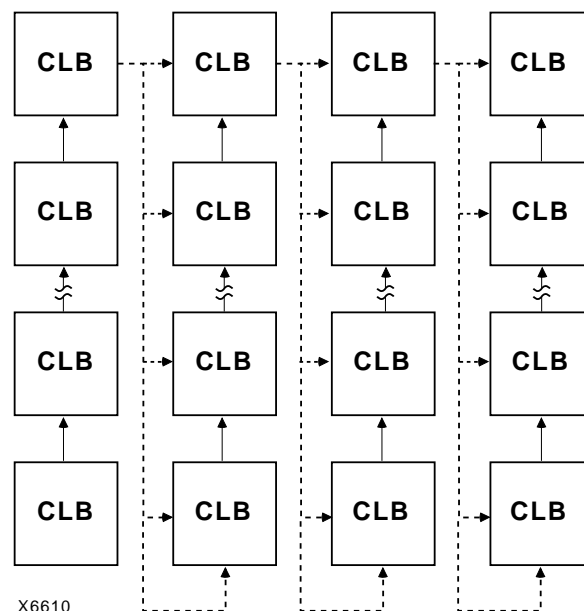
XC4000." This discussion also applies to XC4000E devices, and to XC4000X devices when the minor logic changes are taken into account.

The fast carry logic can be accessed by placing special library symbols, or by using Xilinx Relationally Placed Macros (RPMs) that already include these symbols.



X6687

**Figure 11: Available XC4000E Carry Propagation Paths**



X6610

**Figure 12: Available XC4000X Carry Propagation Paths (dotted lines use general interconnect)**





**Figure 22: 3-State Buffers Implement a Multiplexer**

## Wide Edge Decoders

Dedicated decoder circuitry boosts the performance of wide decoding functions. When the address or data field is wider than the function generator inputs, FPGAs need multi-level decoding and are thus slower than PALs. XC4000 Series CLBs have nine inputs. Any decoder of up to nine inputs is, therefore, compact and fast. However, there is also a need for much wider decoders, especially for address decoding in large microprocessor systems.

An XC4000 Series FPGA has four programmable decoders located on each edge of the device. The inputs to each decoder are any of the IOB I1 signals on that edge plus one local interconnect per CLB row or column. Each row or column of CLBs provides up to three variables or their complements., as shown in Figure 23. Each decoder generates a High output (resistor pull-up) when the AND condition of the selected inputs, or their complements, is true. This is analogous to a product term in typical PAL devices.

Each of these wired-AND gates is capable of accepting up to 42 inputs on the XC4005E and 72 on the XC4013E. There are up to 96 inputs for each decoder on the XC4028X and 132 on the XC4052X. The decoders may also be split in two when a larger number of narrower decoders are required, for a maximum of 32 decoders per device.

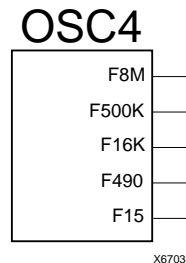
The decoder outputs can drive CLB inputs, so they can be combined with other logic to form a PAL-like AND/OR structure. The decoder outputs can also be routed directly to the chip outputs. For fastest speed, the output should be on the same chip edge as the decoder. Very large PALs can be emulated by ORing the decoder outputs in a CLB. This decoding feature covers what has long been considered a weakness of older FPGAs. Users often resorted to external PALs for simple but fast decoding functions. Now, the dedicated decoders in the XC4000 Series device can implement these functions fast and efficiently.

To use the wide edge decoders, place one or more of the WAND library symbols (WAND1, WAND4, WAND8, WAND16). Attach a DECODE attribute or property to each WAND symbol. Tie the outputs together and attach a PUL-

LUP symbol. Location attributes or properties such as L (left edge) or TR (right half of top edge) should also be used to ensure the correct placement of the decoder inputs.



**Figure 23: XC4000 Series Edge Decoding Example**



**Figure 24: XC4000 Series Oscillator Symbol**

## On-Chip Oscillator

XC4000 Series devices include an internal oscillator. This oscillator is used to clock the power-on time-out, for configuration memory clearing, and as the source of CCLK in Master configuration modes. The oscillator runs at a nominal 8 MHz frequency that varies with process, Vcc, and temperature. The output frequency falls between 4 and 10 MHz.



**Figure 28: Single- and Double-Length Lines, with Programmable Switch Matrices (PSMs)**

### Double-Length Lines

The double-length lines consist of a grid of metal segments, each twice as long as the single-length lines: they run past two CLBs before entering a switch matrix. Double-length lines are grouped in pairs with the switch matrices staggered, so that each line goes through a switch matrix at every other row or column of CLBs (see [Figure 28](#)).

There are four vertical and four horizontal double-length lines associated with each CLB. These lines provide faster signal routing over intermediate distances, while retaining routing flexibility. Double-length lines are connected by way of the programmable switch matrices. Routing connectivity is shown in [Figure 27](#).

### Quad Lines (XC4000X only)

XC4000X devices also include twelve vertical and twelve horizontal quad lines per CLB row and column. Quad lines are four times as long as the single-length lines. They are interconnected via buffered switch matrices (shown as diamonds in [Figure 27 on page 30](#)). Quad lines run past four CLBs before entering a buffered switch matrix. They are grouped in fours, with the buffered switch matrices staggered, so that each line goes through a buffered switch matrix at every fourth CLB location in that row or column. (See [Figure 29](#).)

The buffered switch matrixes have four pins, one on each edge. All of the pins are bidirectional. Any pin can drive any or all of the other pins.

Each buffered switch matrix contains one buffer and six pass transistors. It resembles the programmable switch matrix shown in [Figure 26](#), with the addition of a programmable buffer. There can be up to two independent inputs



**Figure 29: Quad Lines (XC4000X only)**

and up to two independent outputs. Only one of the independent inputs can be buffered.

The place and route software automatically uses the timing requirements of the design to determine whether or not a quad line signal should be buffered. A heavily loaded signal is typically buffered, while a lightly loaded one is not. One scenario is to alternate buffers and pass transistors. This allows both vertical and horizontal quad lines to be buffered at alternating buffered switch matrices.

Due to the buffered switch matrices, quad lines are very fast. They provide the fastest available method of routing heavily loaded signals for long distances across the device.

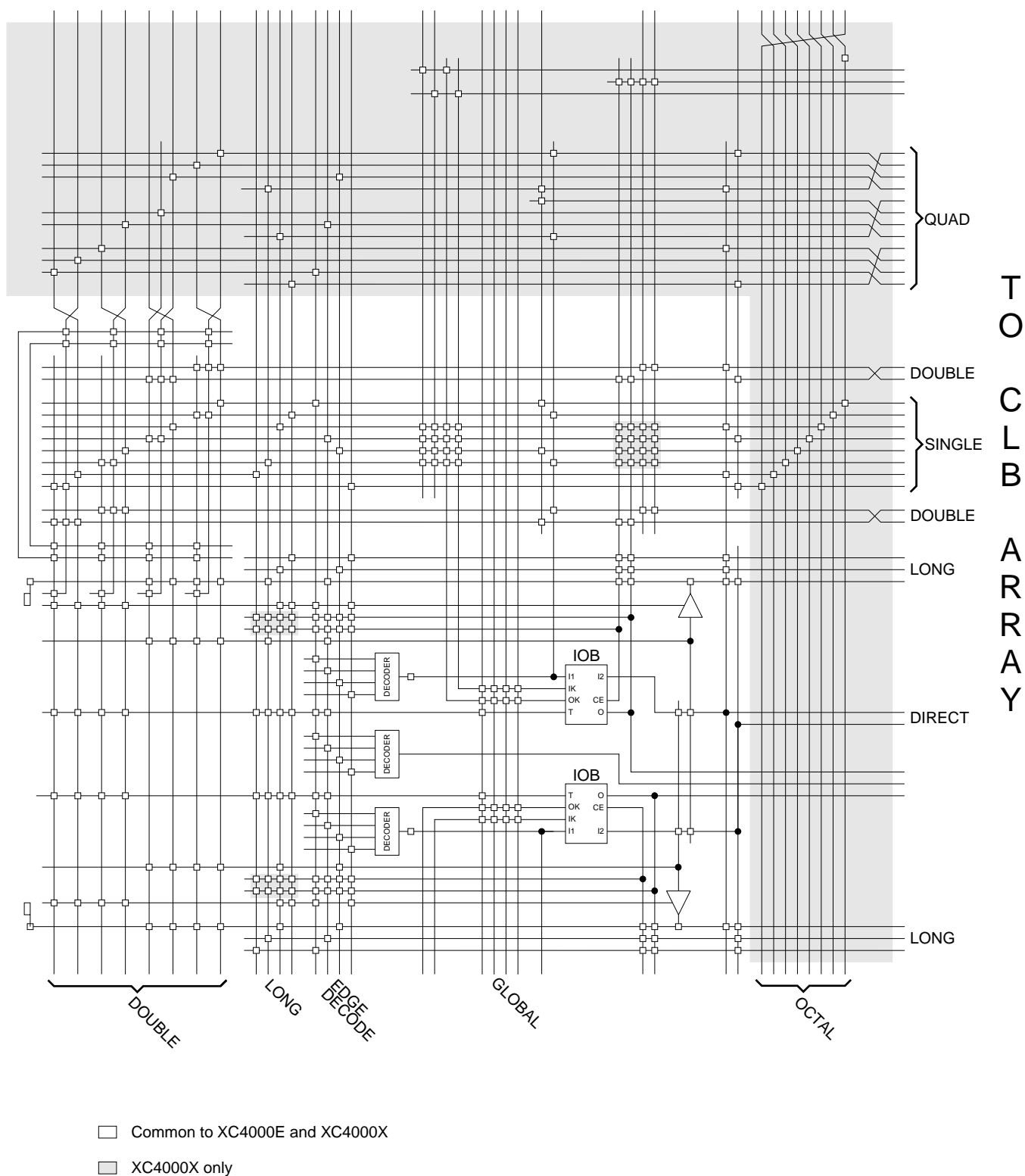
### Longlines

Longlines form a grid of metal interconnect segments that run the entire length or width of the array. Longlines are intended for high fan-out, time-critical signal nets, or nets that are distributed over long distances. In XC4000X devices, quad lines are preferred for critical nets, because the buffered switch matrices make them faster for high fan-out nets.

Two horizontal longlines per CLB can be driven by 3-state or open-drain drivers (TBUFs). They can therefore implement unidirectional or bidirectional buses, wide multiplexers, or wired-AND functions. (See [“Three-State Buffers” on page 26](#) for more details.)

Each horizontal longline driven by TBUFs has either two (XC4000E) or eight (XC4000X) pull-up resistors. To activate these resistors, attach a PULLUP symbol to the long-line net. The software automatically activates the appropriate number of pull-ups. There is also a weak keeper at each end of these two horizontal longlines. This





**Figure 33: Detail of Programmable Interconnect Associated with XC4000 Series IOB (Left Edge)**

**Table 16: Pin Descriptions**

| Pin Name   | I/O During Config. | I/O After Config.            | Pin Description   |
|--|--------------------|------------------------------|---|
| <b>Permanently Dedicated Pins</b>                    |                    |                              |   |
| VCC  | I                  | I                            | Eight or more (depending on package) connections to the nominal +5 V supply voltage (+3.3 V for low-voltage devices). All must be connected, and each must be decoupled with a 0.01 - 0.1 $\mu$ F capacitor to Ground.  |
| GND  | I                  | I                            | Eight or more (depending on package type) connections to Ground. All must be connected.   |
| CCLK   | I or O             | I                            | During configuration, Configuration Clock (CCLK) is an output in Master modes or Asynchronous Peripheral mode, but is an input in Slave mode and Synchronous Peripheral mode. After configuration, CCLK has a weak pull-up resistor and can be selected as the Readback Clock. There is no CCLK High or Low time restriction on XC4000 Series devices, except during Readback. See <a href="#">“Violating the Maximum High and Low Time Specification for the Readback Clock” on page 56</a> for an explanation of this exception.  |
| DONE   | I/O                | O                            | DONE is a bidirectional signal with an optional internal pull-up resistor. As an output, it indicates the completion of the configuration process. As an input, a Low level on DONE can be configured to delay the global logic initialization and the enabling of outputs. The optional pull-up resistor is selected as an option in the XACTstep program that creates the configuration bitstream. The resistor is included by default.   |
| $\overline{\text{PROGRAM}}$                          | I                  | I                            | PROGRAM is an active Low input that forces the FPGA to clear its configuration memory. It is used to initiate a configuration cycle. When PROGRAM goes High, the FPGA finishes the current clear cycle and executes another complete clear cycle, before it goes into a WAIT state and releases INIT.<br>The PROGRAM pin has a permanent weak pull-up, so it need not be externally pulled up to Vcc.   |
| <b>User I/O Pins That Can Have Special Functions</b> |                    |                              |   |
| RDY/ $\overline{\text{BUSY}}$                        | O                  | I/O                          | During Peripheral mode configuration, this pin indicates when it is appropriate to write another byte of data into the FPGA. The same status is also available on D7 in Asynchronous Peripheral mode, if a read operation is performed when the device is selected. After configuration, RDY/ $\overline{\text{BUSY}}$ is a user-programmable I/O pin. RDY/ $\overline{\text{BUSY}}$ is pulled High with a high-impedance pull-up prior to $\overline{\text{INIT}}$ going High.   |
| $\overline{\text{RCLK}}$                             | O                  | I/O                          | During Master Parallel configuration, each change on the A0-A17 outputs (A0 - A21 for XC4000X) is preceded by a rising edge on $\overline{\text{RCLK}}$ , a redundant output signal. $\overline{\text{RCLK}}$ is useful for clocked PROMs. It is rarely used during configuration. After configuration, $\overline{\text{RCLK}}$ is a user-programmable I/O pin.  |
| M0, M1, M2   | I                  | I (M0),<br>O (M1),<br>I (M2) | As Mode inputs, these pins are sampled after $\overline{\text{INIT}}$ goes High to determine the configuration mode to be used. After configuration, M0 and M2 can be used as inputs, and M1 can be used as a 3-state output. These three pins have no associated input or output registers.<br>During configuration, these pins have weak pull-up resistors. For the most popular configuration mode, Slave Serial, the mode pins can thus be left unconnected. The three mode inputs can be individually configured with or without weak pull-up or pull-down resistors. A pull-down resistor value of 4.7 k $\Omega$ is recommended.<br>These pins can only be used as inputs or outputs when called out by special schematic definitions. To use these pins, place the library components MD0, MD1, and MD2 instead of the usual pad symbols. Input or output buffers must still be used. |
| TDO  | O                  | O                            | If boundary scan is used, this pin is the Test Data Output. If boundary scan is not used, this pin is a 3-state output without a register, after configuration is completed.<br>This pin can be user output only when called out by special schematic definitions. To use this pin, place the library component TDO instead of the usual pad symbol. An output buffer must still be used.   |

Table 20: XC4000E Program Data

| Device               | XC4003E          | XC4005E          | XC4006E          | XC4008E          | XC4010E          | XC4013E          | XC4020E          | XC4025E            |
|----------------------|------------------|------------------|------------------|------------------|------------------|------------------|------------------|--------------------|
| Max Logic Gates      | 3,000            | 5,000            | 6,000            | 8,000            | 10,000           | 13,000           | 20,000           | 25,000             |
| CLBs<br>(Row x Col.) | 100<br>(10 x 10) | 196<br>(14 x 14) | 256<br>(16 x 16) | 324<br>(18 x 18) | 400<br>(20 x 20) | 576<br>(24 x 24) | 784<br>(28 x 28) | 1,024<br>(32 x 32) |
| IOBs                 | 80               | 112              | 128              | 144              | 160              | 192              | 224              | 256                |
| Flip-Flops           | 360              | 616              | 768              | 936              | 1,120            | 1,536            | 2,016            | 2,560              |
| Bits per Frame       | 126              | 166              | 186              | 206              | 226              | 266              | 306              | 346                |
| Frames               | 428              | 572              | 644              | 716              | 788              | 932              | 1,076            | 1,220              |
| Program Data         | 53,936           | 94,960           | 119,792          | 147,504          | 178,096          | 247,920          | 329,264          | 422,128            |
| PROM Size<br>(bits)  | 53,984           | 95,008           | 119,840          | 147,552          | 178,144          | 247,968          | 329,312          | 422,176            |

- Notes:
- Bits per Frame = (10 x number of rows) + 7 for the top + 13 for the bottom + 1 + 1 start bit + 4 error check bits  
 Number of Frames = (36 x number of columns) + 26 for the left edge + 41 for the right edge + 1  
 Program Data = (Bits per Frame x Number of Frames) + 8 postamble bits  
 PROM Size = Program Data + 40 (header) + 8
  - The user can add more "one" bits as leading dummy bits in the header, or, if CRC = off, as trailing dummy bits at the end of any frame, following the four error check bits. However, the Length Count value **must** be adjusted for all such extra "one" bits, even for extra leading ones at the beginning of the header.

Table 21: XC4000EX/XL Program Data

| Device                 | XC4002XL      | XC4005           | XC4010           | XC4013           | XC4020           | XC4028             | XC4036             | XC4044             | XC4052             | XC4062             | XC4085             |
|------------------------|---------------|------------------|------------------|------------------|------------------|--------------------|--------------------|--------------------|--------------------|--------------------|--------------------|
| Max Logic Gates        | 2,000         | 5,000            | 10,000           | 13,000           | 20,000           | 28,000             | 36,000             | 44,000             | 52,000             | 62,000             | 85,000             |
| CLBs<br>(Row x Column) | 64<br>(8 x 8) | 196<br>(14 x 14) | 400<br>(20 x 20) | 576<br>(24 x 24) | 784<br>(28 x 28) | 1,024<br>(32 x 32) | 1,296<br>(36 x 36) | 1,600<br>(40 x 40) | 1,936<br>(44 x 44) | 2,304<br>(48 x 48) | 3,136<br>(56 x 56) |
| IOBs                   | 64            | 112              | 160              | 192              | 224              | 256                | 288                | 320                | 352                | 384                | 448                |
| Flip-Flops             | 256           | 616              | 1,120            | 1,536            | 2,016            | 2,560              | 3,168              | 3,840              | 4,576              | 5,376              | 7,168              |
| Bits per Frame         | 133           | 205              | 277              | 325              | 373              | 421                | 469                | 517                | 565                | 613                | 709                |
| Frames                 | 459           | 741              | 1,023            | 1,211            | 1,399            | 1,587              | 1,775              | 1,963              | 2,151              | 2,339              | 2,715              |
| Program Data           | 61,052        | 151,910          | 283,376          | 393,580          | 521,832          | 668,124            | 832,480            | 1,014,876          | 1,215,320          | 1,433,804          | 1,924,940          |
| PROM Size<br>(bits)    | 61,104        | 151,960          | 283,424          | 393,632          | 521,880          | 668,172            | 832,528            | 1,014,924          | 1,215,368          | 1,433,852          | 1,924,992          |

- Notes:
- Bits per frame = (13 x number of rows) + 9 for the top + 17 for the bottom + 8 + 1 start bit + 4 error check bits.  
 Frames = (47 x number of columns) + 27 for the left edge + 52 for the right edge + 4.  
 Program data = (bits per frame x number of frames) + 5 postamble bits.  
 PROM size = (program data + 40 header bits + 8 start bits) rounded up to the nearest byte.
  - The user can add more "one" bits as leading dummy bits in the header, or, if CRC = off, as trailing dummy bits at the end of any frame, following the four error check bits. However, the Length Count value must be adjusted for all such extra "one" bits, even for extra leading "ones" at the beginning of the header.

## Cyclic Redundancy Check (CRC) for Configuration and Readback

The Cyclic Redundancy Check is a method of error detection in data transmission applications. Generally, the transmitting system performs a calculation on the serial bitstream. The result of this calculation is tagged onto the data stream as additional check bits. The receiving system performs an identical calculation on the bitstream and compares the result with the received checksum.

Each data frame of the configuration bitstream has four error bits at the end, as shown in [Table 19](#). If a frame data error is detected during the loading of the FPGA, the con-

figuration process with a potentially corrupted bitstream is terminated. The FPGA pulls the  $\overline{\text{INIT}}$  pin Low and goes into a Wait state.

During Readback, 11 bits of the 16-bit checksum are added to the end of the Readback data stream. The checksum is computed using the CRC-16 CCITT polynomial, as shown in [Figure 45](#). The checksum consists of the 11 most significant bits of the 16-bit code. A change in the checksum indicates a change in the Readback bitstream. A comparison to a previous checksum is meaningful only if the readback data is independent of the current device state. CLB outputs should not be included (Read Capture option not

used), and if RAM is present, the RAM content must be unchanged.

Statistically, one error out of 2048 might go undetected.

## Configuration Sequence

There are four major steps in the XC4000 Series power-up configuration sequence.

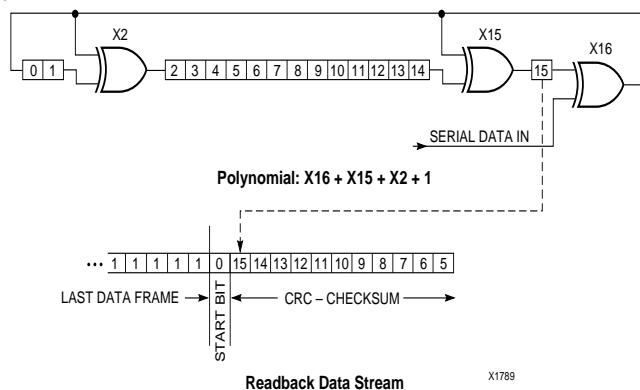
- Configuration Memory Clear
- Initialization
- Configuration
- Start-Up

The full process is illustrated in Figure 46.

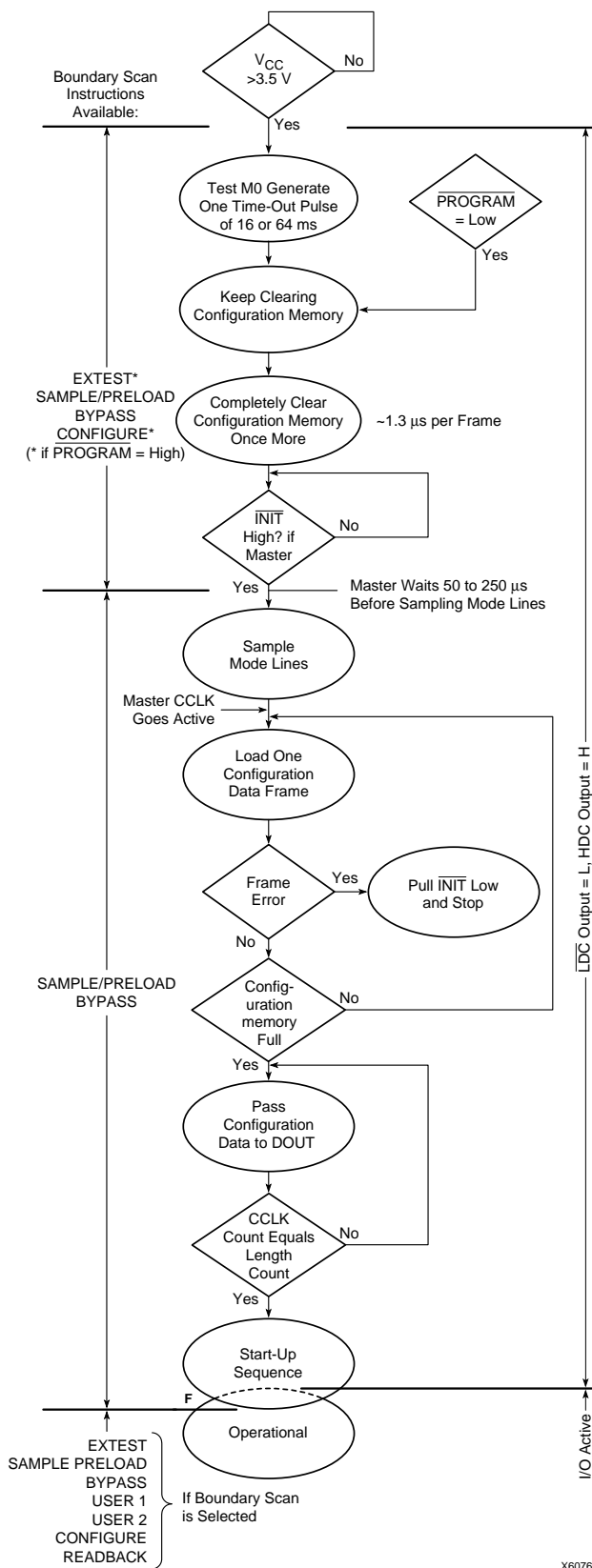
### Configuration Memory Clear

When power is first applied or is reapplied to an FPGA, an internal circuit forces initialization of the configuration logic. When  $V_{CC}$  reaches an operational level, and the circuit passes the write and read test of a sample pair of configuration bits, a time delay is started. This time delay is nominally 16 ms, and up to 10% longer in the low-voltage devices. The delay is four times as long when in Master Modes (M0 Low), to allow ample time for all slaves to reach a stable  $V_{CC}$ . When all  $\overline{INIT}$  pins are tied together, as recommended, the longest delay takes precedence. Therefore, devices with different time delays can easily be mixed and matched in a daisy chain.

This delay is applied only on power-up. It is not applied when re-configuring an FPGA by pulsing the PROGRAM pin



**Figure 45: Circuit for Generating CRC-16**



**Figure 46: Power-up Configuration Sequence**

The default option, and the most practical one, is for DONE to go High first, disconnecting the configuration data source and avoiding any contention when the I/Os become active one clock later. Reset/Set is then released another clock period later to make sure that user-operation starts from stable internal conditions. This is the most common sequence, shown with heavy lines in [Figure 47](#), but the designer can modify it to meet particular requirements.

Normally, the start-up sequence is controlled by the internal device oscillator output (CCLK), which is asynchronous to the system clock.

XC4000 Series offers another start-up clocking option, UCLK\_NOSYNC. The three events described above need not be triggered by CCLK. They can, as a configuration option, be triggered by a user clock. This means that the device can wake up in synchronism with the user system.

When the UCLK\_SYNC option is enabled, the user can externally hold the open-drain DONE output Low, and thus stall all further progress in the start-up sequence until DONE is released and has gone High. This option can be used to force synchronization of several FPGAs to a common user clock, or to guarantee that all devices are successfully configured before any I/Os go active.

If either of these two options is selected, and no user clock is specified in the design or attached to the device, the chip could reach a point where the configuration of the device is complete and the Done pin is asserted, but the outputs do not become active. The solution is either to recreate the bit-stream specifying the start-up clock as CCLK, or to supply the appropriate user clock.

### Start-up Sequence

The Start-up sequence begins when the configuration memory is full, and the total number of configuration clocks

received since  $\overline{\text{INIT}}$  went High equals the loaded value of the length count.

The next rising clock edge sets a flip-flop Q0, shown in [Figure 48](#). Q0 is the leading bit of a 5-bit shift register. The outputs of this register can be programmed to control three events.

- The release of the open-drain DONE output
- The change of configuration-related pins to the user function, activating all IOBs.
- The termination of the global Set/Reset initialization of all CLB and IOB storage elements.

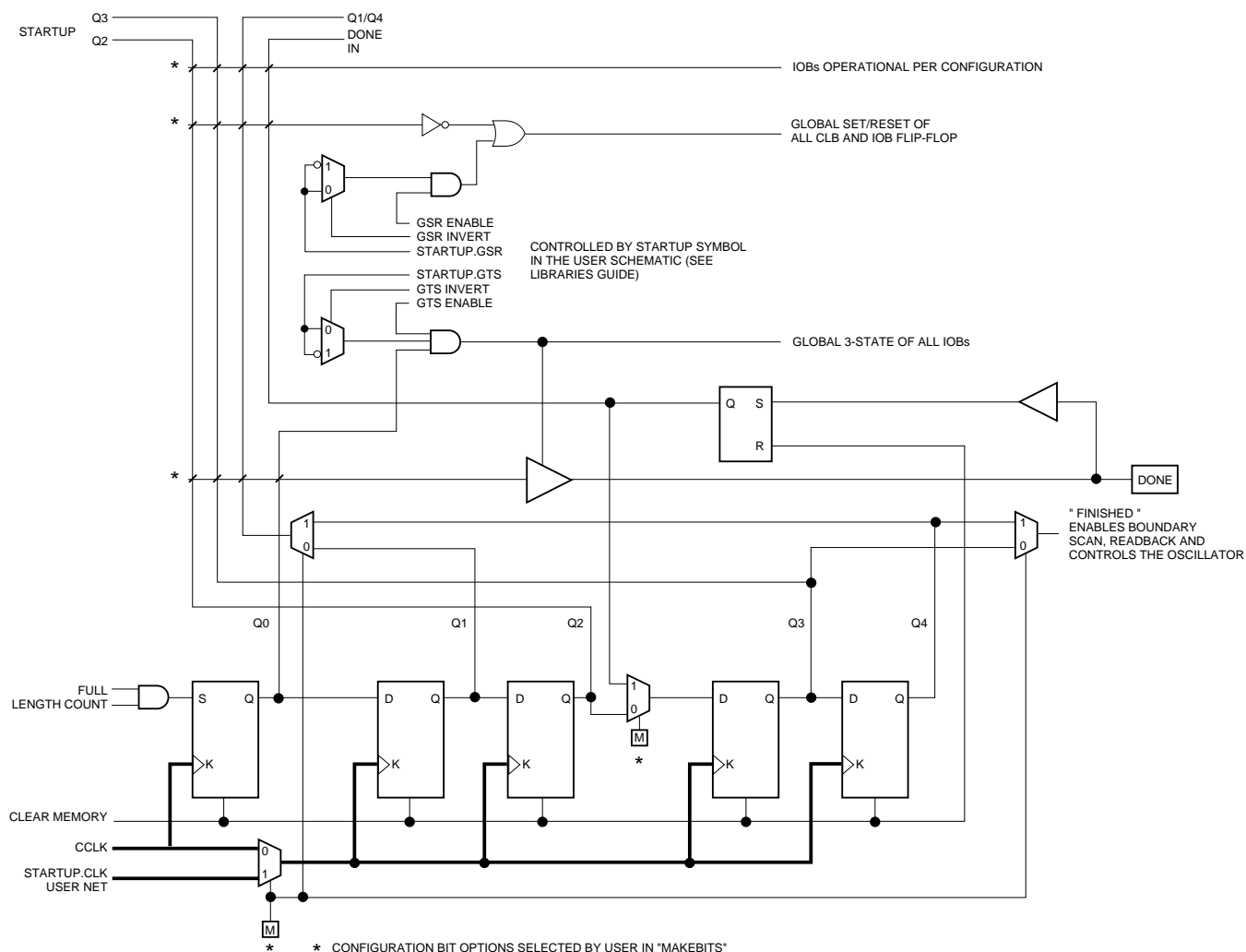
The DONE pin can also be wire-ANDed with DONE pins of other FPGAs or with other external signals, and can then be used as input to bit Q3 of the start-up register. This is called “Start-up Timing Synchronous to Done In” and is selected by either CCLK\_SYNC or UCLK\_SYNC.

When DONE is not used as an input, the operation is called “Start-up Timing Not Synchronous to DONE In,” and is selected by either CCLK\_NOSYNC or UCLK\_NOSYNC.

As a configuration option, the start-up control register beyond Q0 can be clocked either by subsequent CCLK pulses or from an on-chip user net called STARTUP.CLK. These signals can be accessed by placing the STARTUP library symbol.

### Start-up from CCLK

If CCLK is used to drive the start-up, Q0 through Q3 provide the timing. Heavy lines in [Figure 47](#) show the default timing, which is compatible with XC2000 and XC3000 devices using early DONE and late Reset. The thin lines indicate all other possible timing options.



**Figure 48: Start-up Logic**

## Readback

The user can read back the content of configuration memory and the level of certain internal nodes without interfering with the normal operation of the device.

Readback not only reports the downloaded configuration bits, but can also include the present state of the device, represented by the content of all flip-flops and latches in CLBs and IOBs, as well as the content of function generators used as RAMs.

Note that in XC4000 Series devices, configuration data is *not* inverted with respect to configuration as it is in XC2000 and XC3000 families.

XC4000 Series Readback does not use any dedicated pins, but uses four internal nets (RDBK.TRIG, RDBK.DATA, RDBK.RIP and RDBK.CLK) that can be routed to any IOB. To access the internal Readback signals, place the READ-

BACK library symbol and attach the appropriate pad symbols, as shown in Figure 49.

After Readback has been initiated by a High level on RDBK.TRIG after configuration, the RDBK.RIP (Read In Progress) output goes High on the next rising edge of RDBK.CLK. Subsequent rising edges of this clock shift out Readback data on the RDBK.DATA net.

Readback data does not include the preamble, but starts with five dummy bits (all High) followed by the Start bit (Low) of the first frame. The first two data bits of the first frame are always High.

Each frame ends with four error check bits. They are read back as High. The last seven bits of the last frame are also read back as High. An additional Start bit (Low) and an 11-bit Cyclic Redundancy Check (CRC) signature follow, before RDBK.RIP returns Low.



**Table 22: Pin Functions During Configuration**

| CONFIGURATION MODE <M2:M1:M0> |                          |                              |                               |                                 |                               | USER OPERATION |
|-------------------------------|--------------------------|------------------------------|-------------------------------|---------------------------------|-------------------------------|----------------|
| SLAVE SERIAL<br><1:1:1>       | MASTER SERIAL<br><0:0:0> | SYNCH. PERIPHERAL<br><0:1:1> | ASYNCH. PERIPHERAL<br><1:0:1> | MASTER PARALLEL DOWN<br><1:1:0> | MASTER PARALLEL UP<br><1:0:0> |                |
| M2(HIGH) (I)                  | M2(LOW) (I)              | M2(LOW) (I)                  | M2(HIGH) (I)                  | M2(HIGH) (I)                    | M2(HIGH) (I)                  | (I)            |
| M1(HIGH) (I)                  | M1(LOW) (I)              | M1(HIGH) (I)                 | M1(LOW) (I)                   | M1(HIGH) (I)                    | M1(LOW) (I)                   | (O)            |
| M0(HIGH) (I)                  | M0(LOW) (I)              | M0(HIGH) (I)                 | M0(HIGH) (I)                  | M0(LOW) (I)                     | M0(LOW) (I)                   | (I)            |
| HDC (HIGH)                    | HDC (HIGH)               | HDC (HIGH)                   | HDC (HIGH)                    | HDC (HIGH)                      | HDC (HIGH)                    | I/O            |
| LDC (LOW)                     | LDC (LOW)                | LDC (LOW)                    | LDC (LOW)                     | LDC (LOW)                       | LDC (LOW)                     | I/O            |
| INIT                          | INIT                     | INIT                         | INIT                          | INIT                            | INIT                          | I/O            |
| DONE                          | DONE                     | DONE                         | DONE                          | DONE                            | DONE                          | DONE           |
| PROGRAM (I)                   | PROGRAM (I)              | PROGRAM (I)                  | PROGRAM (I)                   | PROGRAM (I)                     | PROGRAM (I)                   | PROGRAM        |
| CCLK (I)                      | CCLK (O)                 | CCLK (I)                     | CCLK (O)                      | CCLK (O)                        | CCLK (O)                      | CCLK (I)       |
|                               |                          | RDY/BUSY (O)                 | RDY/BUSY (O)                  | RCLK (O)                        | RCLK (O)                      | I/O            |
|                               |                          |                              | RS (I)                        |                                 |                               | I/O            |
|                               |                          |                              | CS0 (I)                       |                                 |                               | I/O            |
|                               |                          | DATA 7 (I)                   | DATA 7 (I)                    | DATA 7 (I)                      | DATA 7 (I)                    | I/O            |
|                               |                          | DATA 6 (I)                   | DATA 6 (I)                    | DATA 6 (I)                      | DATA 6 (I)                    | I/O            |
|                               |                          | DATA 5 (I)                   | DATA 5 (I)                    | DATA 5 (I)                      | DATA 5 (I)                    | I/O            |
|                               |                          | DATA 4 (I)                   | DATA 4 (I)                    | DATA 4 (I)                      | DATA 4 (I)                    | I/O            |
|                               |                          | DATA 3 (I)                   | DATA 3 (I)                    | DATA 3 (I)                      | DATA 3 (I)                    | I/O            |
|                               |                          | DATA 2 (I)                   | DATA 2 (I)                    | DATA 2 (I)                      | DATA 2 (I)                    | I/O            |
|                               |                          | DATA 1 (I)                   | DATA 1 (I)                    | DATA 1 (I)                      | DATA 1 (I)                    | I/O            |
| DIN (I)                       | DIN (I)                  | DATA 0 (I)                   | DATA 0 (I)                    | DATA 0 (I)                      | DATA 0 (I)                    | I/O            |
| DOUT                          | DOUT                     | DOUT                         | DOUT                          | DOUT                            | DOUT                          | SGCK4-GCK6-I/O |
| TDI                           | TDI                      | TDI                          | TDI                           | TDI                             | TDI                           | TDI-I/O        |
| TCK                           | TCK                      | TCK                          | TCK                           | TCK                             | TCK                           | TCK-I/O        |
| TMS                           | TMS                      | TMS                          | TMS                           | TMS                             | TMS                           | TMS-I/O        |
| TDO                           | TDO                      | TDO                          | TDO                           | TDO                             | TDO                           | TDO-(O)        |
|                               |                          |                              | WS (I)                        | A0                              | A0                            | I/O            |
|                               |                          |                              |                               | A1                              | A1                            | PGCK4-GCK7-I/O |
|                               |                          |                              | CS1                           | A2                              | A2                            | I/O            |
|                               |                          |                              |                               | A3                              | A3                            | I/O            |
|                               |                          |                              |                               | A4                              | A4                            | I/O            |
|                               |                          |                              |                               | A5                              | A5                            | I/O            |
|                               |                          |                              |                               | A6                              | A6                            | I/O            |
|                               |                          |                              |                               | A7                              | A7                            | I/O            |
|                               |                          |                              |                               | A8                              | A8                            | I/O            |
|                               |                          |                              |                               | A9                              | A9                            | I/O            |
|                               |                          |                              |                               | A10                             | A10                           | I/O            |
|                               |                          |                              |                               | A11                             | A11                           | I/O            |
|                               |                          |                              |                               | A12                             | A12                           | I/O            |
|                               |                          |                              |                               | A13                             | A13                           | I/O            |
|                               |                          |                              |                               | A14                             | A14                           | I/O            |
|                               |                          |                              |                               | A15                             | A15                           | SGCK1-GCK8-I/O |
|                               |                          |                              |                               | A16                             | A16                           | PGCK1-GCK1-I/O |
|                               |                          |                              |                               | A17                             | A17                           | I/O            |
|                               |                          |                              |                               | A18*                            | A18*                          | I/O            |
|                               |                          |                              |                               | A19*                            | A19*                          | I/O            |
|                               |                          |                              |                               | A20*                            | A20*                          | I/O            |
|                               |                          |                              |                               | A21*                            | A21*                          | I/O            |
|                               |                          |                              |                               |                                 |                               | ALL OTHERS     |

## Configuration Timing

The seven configuration modes are discussed in detail in this section. Timing specifications are included.

### Slave Serial Mode

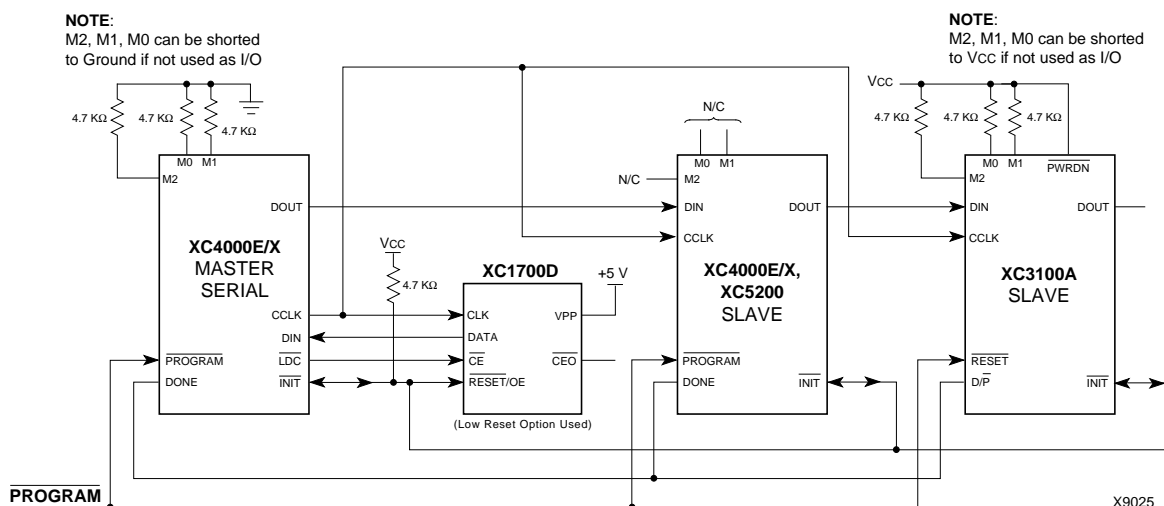
In Slave Serial mode, an external signal drives the CCLK input of the FPGA. The serial configuration bitstream must be available at the DIN input of the lead FPGA a short setup time before each rising CCLK edge.

The lead FPGA then presents the preamble data—and all data that overflows the lead device—on its DOUT pin.

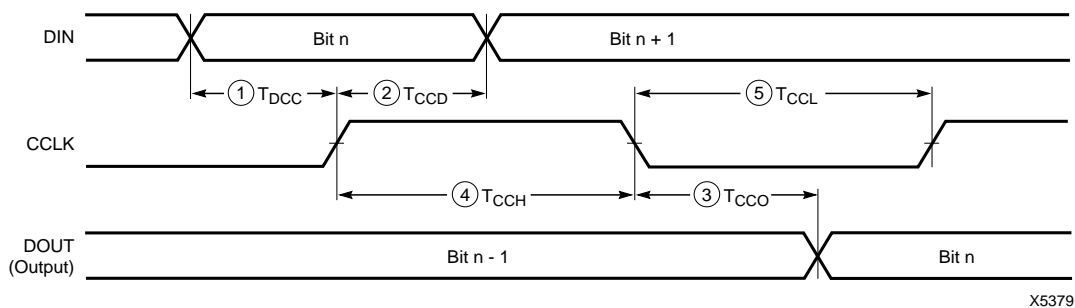
There is an internal delay of 0.5 CCLK periods, which means that DOUT changes on the falling CCLK edge, and the next FPGA in the daisy chain accepts data on the subsequent rising CCLK edge.

**Figure 51** shows a full master/slave system. An XC4000 Series device in Slave Serial mode should be connected as shown in the third device from the left.

Slave Serial mode is selected by a <111> on the mode pins (M2, M1, M0). Slave Serial is the default mode if the mode pins are left unconnected, as they have weak pull-up resistors during configuration.



**Figure 51: Master/Slave Serial Mode Circuit Diagram**



|      | Description | Symbol      | Min | Max | Units |
|------|-------------|-------------|-----|-----|-------|
| CCLK | DIN setup   | 1 $T_{DCC}$ | 20  |     | ns    |
|      | DIN hold    | 2 $T_{CCD}$ | 0   |     | ns    |
|      | DIN to DOUT | 3 $T_{CCO}$ |     | 30  | ns    |
|      | High time   | 4 $T_{CCH}$ | 45  |     | ns    |
|      | Low time    | 5 $T_{CCL}$ | 45  |     | ns    |
|      | Frequency   | $F_{CC}$    |     | 10  | MHz   |

Note: Configuration must be delayed until the INIT pins of all daisy-chained FPGAs are High.

**Figure 52: Slave Serial Mode Programming Switching Characteristics**

## Master Serial Mode

In Master Serial mode, the CCLK output of the lead FPGA drives a Xilinx Serial PROM that feeds the FPGA DIN input. Each rising edge of the CCLK output increments the Serial PROM internal address counter. The next data bit is put on the SPROM data output, connected to the FPGA DIN pin. The lead FPGA accepts this data on the subsequent rising CCLK edge.

The lead FPGA then presents the preamble data—and all data that overflows the lead device—on its DOUT pin. There is an internal pipeline delay of 1.5 CCLK periods, which means that DOUT changes on the falling CCLK edge, and the next FPGA in the daisy chain accepts data on the subsequent rising CCLK edge.

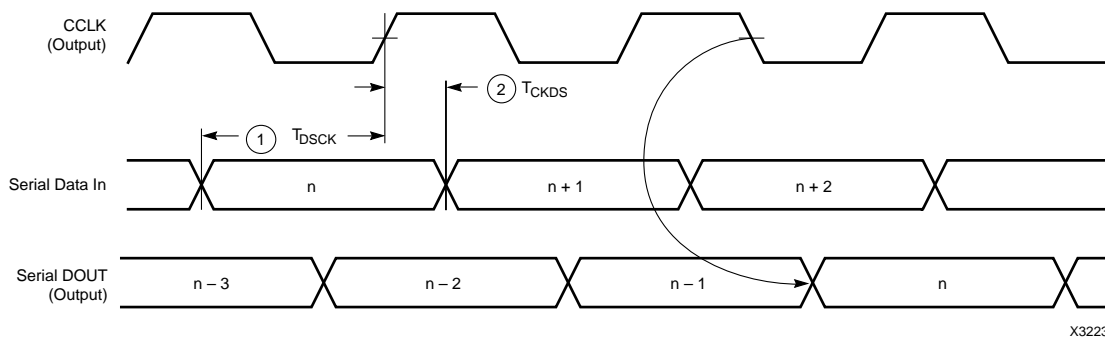
In the bitstream generation software, the user can specify Fast ConfigRate, which, starting several bits into the first frame, increases the CCLK frequency by a factor of eight.

For actual timing values please refer to “**Configuration Switching Characteristics**” on page 68. Be sure that the serial PROM and slaves are fast enough to support this data rate. XC2000, XC3000/A, and XC3100A devices do not support the Fast ConfigRate option.

The SPROM CE input can be driven from either  $\overline{\text{LDC}}$  or DONE. Using  $\overline{\text{LDC}}$  avoids potential contention on the DIN pin, if this pin is configured as user-I/O, but  $\overline{\text{LDC}}$  is then restricted to be a permanently High user output after configuration. Using DONE can also avoid contention on DIN, provided the early DONE option is invoked.

Figure 51 on page 60 shows a full master/slave system. The leftmost device is in Master Serial mode.

Master Serial mode is selected by a <000> on the mode pins (M2, M1, M0).



|      | Description | Symbol       | Min | Max | Units |
|------|-------------|--------------|-----|-----|-------|
| CCLK | DIN setup   | 1 $T_{DSCK}$ | 20  |     | ns    |
|      | DIN hold    | 2 $T_{CKDS}$ | 0   |     | ns    |

Notes: 1. At power-up, Vcc must rise from 2.0 V to Vcc min in less than 25 ms, otherwise delay configuration by pulling PROGRAM Low until Vcc is valid.  
2. Master Serial mode timing is based on testing in slave mode.

**Figure 53: Master Serial Mode Programming Switching Characteristics**

## Master Parallel Modes

In the two Master Parallel modes, the lead FPGA directly addresses an industry-standard byte-wide EPROM, and accepts eight data bits just before incrementing or decrementing the address outputs.

The eight data bits are serialized in the lead FPGA, which then presents the preamble data—and all data that overflows the lead device—on its DOUT pin. There is an internal delay of 1.5 CCLK periods, after the rising CCLK edge that accepts a byte of data (and also changes the EPROM address) until the falling CCLK edge that makes the LSB (D0) of this byte appear at DOUT. This means that DOUT changes on the falling CCLK edge, and the next FPGA in the daisy chain accepts data on the subsequent rising CCLK edge.

The PROM address pins can be incremented or decremented, depending on the mode pin settings. This option allows the FPGA to share the PROM with a wide variety of microprocessors and micro controllers. Some processors must boot from the bottom of memory (all zeros) while others must boot from the top. The FPGA is flexible and can load its configuration bitstream from either end of the memory.

Master Parallel Up mode is selected by a <100> on the mode pins (M2, M1, M0). The EPROM addresses start at 00000 and increment.

Master Parallel Down mode is selected by a <110> on the mode pins. The EPROM addresses start at 3FFFF and decrement.

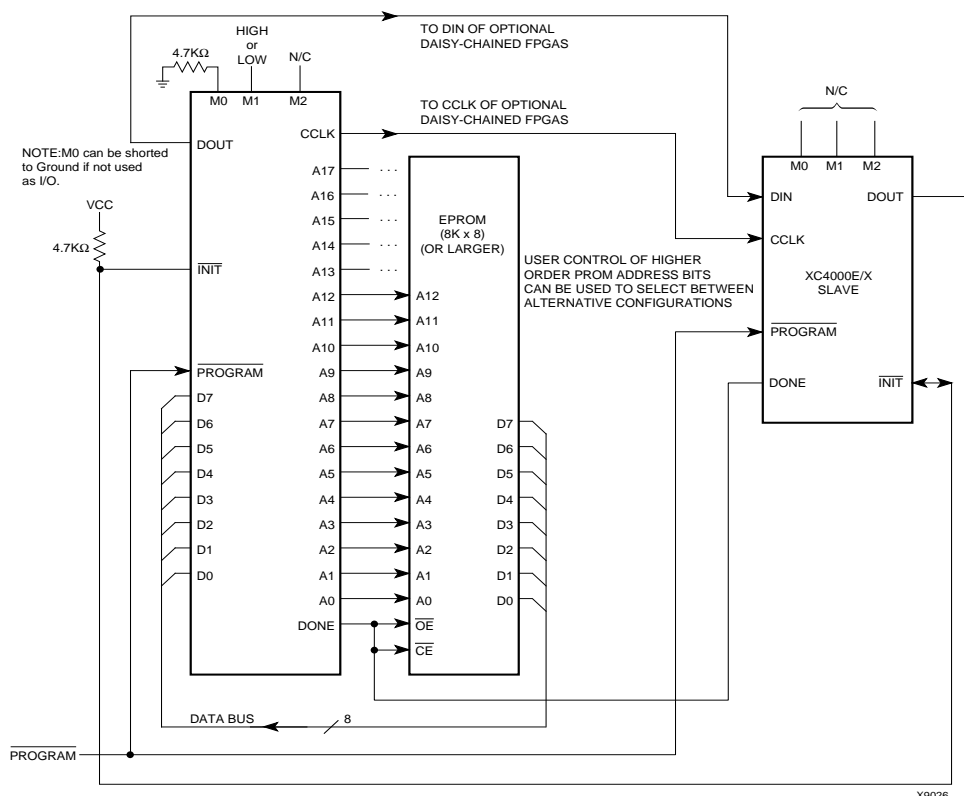
### Additional Address lines in XC4000 devices

The XC4000X devices have additional address lines (A18-A21) allowing the additional address space required to daisy-chain several large devices.

The extra address lines are programmable in XC4000EX devices. By default these address lines are not activated. In the default mode, the devices are compatible with existing XC4000 and XC4000E products. If desired, the extra address lines can be used by specifying the address lines option in bitgen as 22 (bitgen -g AddressLines:22). The lines (A18-A21) are driven when a master device detects, via the bitstream, that it should be using all 22 address lines. Because these pins will initially be pulled high by internal pull-ups, designers using Master Parallel Up mode should use external pull down resistors on pins A18-A21. If Master Parallel Down mode is used external resistors are not necessary.

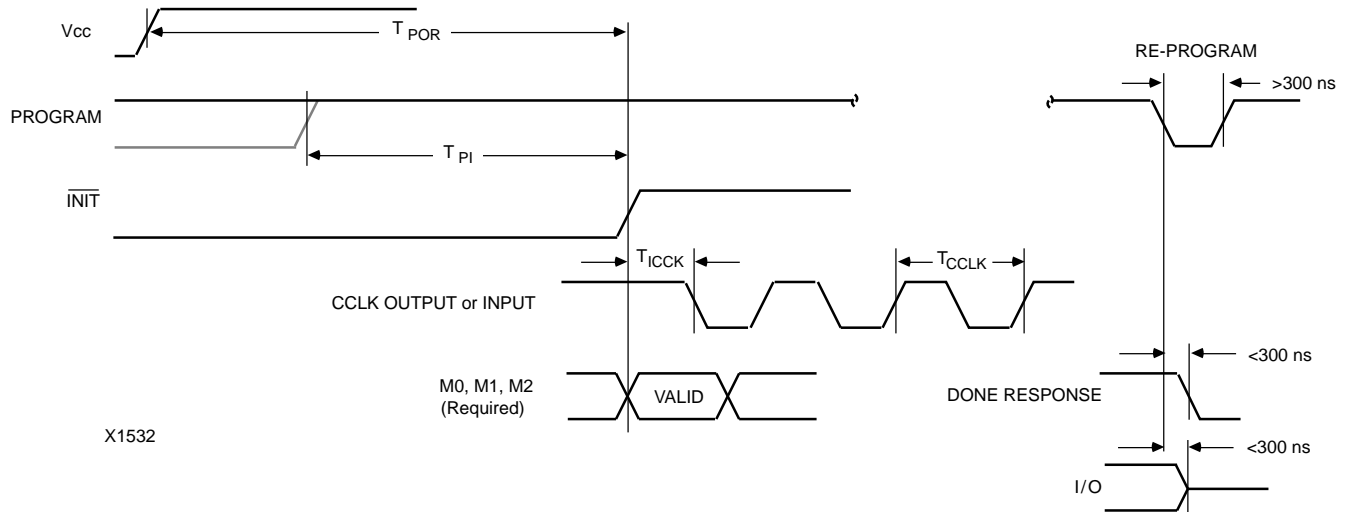
All 22 address lines are always active in Master Parallel modes with XC4000XL devices. The additional address lines behave identically to the lower order address lines. If the Address Lines option in bitgen is set to 18, it will be ignored by the XC4000XL device.

The additional address lines (A18-A21) are not available in the PC84 package.



**Figure 54: Master Parallel Mode Circuit Diagram**

## Configuration Switching Characteristics



X1532

### Master Modes (XC4000E/EX)

| Description                |           | Symbol     | Min | Max  | Units                  |
|----------------------------|-----------|------------|-----|------|------------------------|
| Power-On Reset             | M0 = High | $T_{POR}$  | 10  | 40   | ms                     |
|                            | M0 = Low  | $T_{POR}$  | 40  | 130  | ms                     |
| Program Latency            |           | $T_{PI}$   | 30  | 200  | $\mu$ s per CLB column |
| CCLK (output) Delay        |           | $T_{ICCK}$ | 40  | 250  | $\mu$ s                |
| CCLK (output) Period, slow |           | $T_{CCLK}$ | 640 | 2000 | ns                     |
| CCLK (output) Period, fast |           | $T_{CCLK}$ | 80  | 250  | ns                     |

### Master Modes (XC4000XL)

| Description                |           | Symbol     | Min | Max  | Units                  |
|----------------------------|-----------|------------|-----|------|------------------------|
| Power-On Reset             | M0 = High | $T_{POR}$  | 10  | 40   | ms                     |
|                            | M0 = Low  | $T_{POR}$  | 40  | 130  | ms                     |
| Program Latency            |           | $T_{PI}$   | 30  | 200  | $\mu$ s per CLB column |
| CCLK (output) Delay        |           | $T_{ICCK}$ | 40  | 250  | $\mu$ s                |
| CCLK (output) Period, slow |           | $T_{CCLK}$ | 540 | 1600 | ns                     |
| CCLK (output) Period, fast |           | $T_{CCLK}$ | 67  | 200  | ns                     |

### Slave and Peripheral Modes (All)

| Description                    | Symbol     | Min | Max | Units                  |
|--------------------------------|------------|-----|-----|------------------------|
| Power-On Reset                 | $T_{POR}$  | 10  | 33  | ms                     |
| Program Latency                | $T_{PI}$   | 30  | 200 | $\mu$ s per CLB column |
| CCLK (input) Delay (required)  | $T_{ICCK}$ | 4   |     | $\mu$ s                |
| CCLK (input) Period (required) | $T_{CCLK}$ | 100 |     | ns                     |

## User I/O Per Package

Table 27, Table 28, and Table 29 show the number of user I/Os available in each package for XC4000-Series devices. Call your local sales office for the latest availability information, or see the Xilinx website at <http://www.xilinx.com> for the latest revision of the specifications.

**Table 27: User I/O Chart for XC4000XL FPGAs**

| Device   | Max I/O | Maximum User Accessible I/O by Package Type |       |       |       |       |       |       |       |       |       |       |       |       |       |       |       |       |       |       |       |       |       |
|----------|---------|---|-------|-------|-------|-------|-------|-------|-------|-------|-------|-------|-------|-------|-------|-------|-------|-------|-------|-------|-------|-------|-------|
|          |         | PC84  | PQ100 | VQ100 | TQ144 | HT144 | HQ160 | PQ160 | TQ176 | HT176 | HQ208 | PQ208 | HQ240 | PQ240 | BG256 | PG299 | HQ304 | BG352 | PG411 | BG432 | PG475 | PG559 | BG560 |
| XC4002XL | 64      | 61  | 64    | 64    |       |       |       |       |       |       |       |       |       |       |       |       |       |       |       |       |       |       |       |
| XC4005XL | 112     | 61  | 77    | 77    | 112   |       |       | 112   |       |       |       | 112   |       |       |       |       |       |       |       |       |       |       |       |
| XC4010XL | 160     | 61  | 77    |       | 113   |       |       | 129   | 145   |       |       | 160   |       |       | 160   |       |       |       |       |       |       |       |       |
| XC4013XL | 192     |   |       |       |       | 113   |       | 129   |       | 145   |       | 160   |       | 192   | 192   |       |       |       |       |       |       |       |       |
| XC4020XL | 224     |   |       |       |       | 113   |       | 129   |       | 145   |       | 160   |       | 192   | 205   |       |       |       |       |       |       |       |       |
| XC4028XL | 256     |   |       |       |       |       | 129   |       |       |       | 160   |       | 193   |       | 205   | 256   | 256   | 256   |       |       |       |       |       |
| XC4036XL | 288     |   |       |       |       |       | 129   |       |       |       | 160   |       | 193   |       |       |       | 256   | 288   | 288   | 288   |       |       |       |
| XC4044XL | 320     |   |       |       |       |       | 129   |       |       |       | 160   |       | 193   |       |       |       | 256   | 289   | 320   | 320   |       |       |       |
| XC4052XL | 352     |   |       |       |       |       |       |       |       |       |       |       | 193   |       |       |       | 256   |       | 352   | 352   |       |       | 352   |
| XC4062XL | 384     |   |       |       |       |       |       |       |       |       |       |       | 193   |       |       |       | 256   |       |       | 352   | 384   |       | 384   |
| XC4085XL | 448     |   |       |       |       |       |       |       |       |       |       |       |       |       |       |       |       |       |       | 352   |       | 448   | 448   |

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**Table 28: User I/O Chart for XC4000E FPGAs**

| Device  | Max I/O | Maximum User Accessible I/O by Package Type |       |       |       |       |       |       |       |       |       |       |       |       |       |       |       |
|---------|---------|---|-------|-------|-------|-------|-------|-------|-------|-------|-------|-------|-------|-------|-------|-------|-------|
|         |         | PC84  | PQ100 | VQ100 | PG120 | TQ144 | PG156 | PQ160 | PG191 | HQ208 | PQ208 | PG223 | BG225 | HQ240 | PQ240 | PG299 | HQ304 |
| XC4003E | 80      | 61  | 77    | 77    | 80    |       |       |       |       |       |       |       |       |       |       |       |       |
| XC4005E | 112     | 61  | 77    |       |       | 112   | 112   | 112   |       |       | 112   |       |       |       |       |       |       |
| XC4006E | 128     | 61  |       |       |       | 113   | 125   | 128   |       |       | 128   |       |       |       |       |       |       |
| XC4008E | 144     | 61  |       |       |       |       |       | 129   | 144   |       | 144   |       |       |       |       |       |       |
| XC4010E | 160     | 61  |       |       |       |       |       | 129   | 160   | 160   | 160   |       | 160   |       |       |       |       |
| XC4013E | 192     |   |       |       |       |       |       | 129   |       | 160   | 160   | 192   | 192   | 192   | 192   |       |       |
| XC4020E | 224     |   |       |       |       |       |       |       |       | 160   |       | 192   |       | 193   |       |       |       |
| XC4025E | 256     |   |       |       |       |       |       |       |       |       |       | 192   |       | 193   |       | 256   | 256   |

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**Table 29: User I/O Chart for XC4000EX FPGAs**

| Device   | Max I/O | Maximum User Accessible I/O by Package Type |       |       |       |       |       |       |
|----------|---------|---|-------|-------|-------|-------|-------|-------|
|          |         | HQ208                                       | HQ240 | PG299 | HQ304 | BG352 | PG411 | BG432 |
| XC4028EX | 256     | 160   | 193   | 256   | 256   | 256   |       |       |
| XC4036EX | 288     |   | 193   |       | 256   | 288   | 288   | 288   |

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## XC4000 Series Electrical Characteristics and Device-Specific Pinout Table

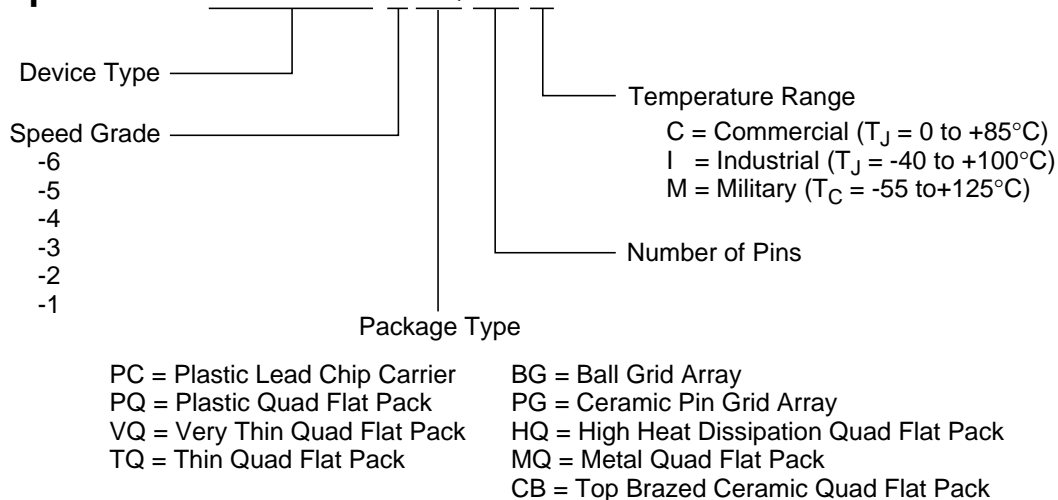
For the latest Electrical Characteristics and package/pinout information for each XC4000 Family, see the Xilinx web site at

[http://www.xilinx.com/xlnx/xweb/xil\\_publications\\_index.jsp](http://www.xilinx.com/xlnx/xweb/xil_publications_index.jsp)

## Ordering Information

### Example:

# XC4013E-3HQ240C



X9020

## Revision Control

| Version       | Description  |
|---------------|--|
| 3/30/98 (1.5) | Updated XC4000XL timing and added XC4002XL   |
| 1/29/99 (1.5) | Updated pin diagrams   |
| 5/14/99 (1.6) | Replaced Electrical Specification and pinout pages for E, EX, and XL families with separate updates and added URL link for electrical specifications/pinouts for Web users |